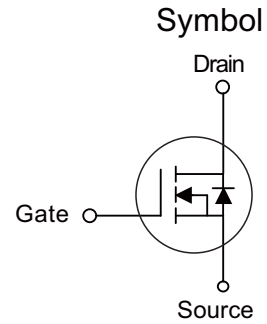


■ PRODUCT CHARACTERISTICS

VDSS	40V
$R_{DS(on)}$ Typ(@ $V_{GS}=4.5$ V)	10m $\Omega$
$R_{DS(on)}$ Typ(@ $V_{GS}=10$ V)	6m $\Omega$
ID	45A



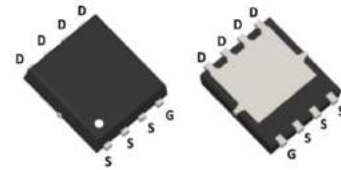
■ APPLICATIONS

- DC/DC Converter

■ FEATURES

- Very low on-resistance  $R_{DS(on)}$
- Pb-free lead plating

PDFN3X3-8L



■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT4170J	PDFN3X3	5000 pieces /Reel

■ ABSOLUTE MAXIMUM RATINGS ( $T_A=25^{\circ}\text{C}$ , unless otherwise specified)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous (Silicon Limited )	$I_D$	45	A
Drain Current-Continuous( $T_C=100^{\circ}\text{C}$ )	$I_D(100^{\circ}\text{C})$	31.8	A
Pulsed Drain Current ( Package Limited )	$I_{DM}$	180	A
Maximum Power Dissipation	$P_D$	28	W
Derating factor		0.22	W/ $^{\circ}\text{C}$
Single pulse avalanche energy	$E_{AS}$	115	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	$^{\circ}\text{C}$

■ THERMAL DATA

Parameter	Symbol	Limit	Unit
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	4.5	$^{\circ}\text{C}/\text{W}$

■ Electrical Characteristics ( $T_c=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	40	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=40V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
On characteristics						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.6	2.5	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$	-	6	7.2	m $\Omega$
		$V_{GS}=4.5V, I_D=20A$	-	10	12	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=5V, I_D=20A$	-	30	-	S
Dynamic characteristics						
Input Capacitance	$C_{iss}$	$V_{DS}=20V, V_{GS}=0V,$ $F=1.0MHz$	-	831	-	PF
Output Capacitance	$C_{oss}$		-	318	-	PF
Reverse Transfer Capacitance	$C_{rss}$		-	24	-	PF
Switching characteristics						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=20V, I_D=20A$ $V_{GS}=10V, R_G=1.6\Omega$	-	6	-	nS
Turn-on Rise Time	$t_r$		-	2.8	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	23	-	nS
Turn-Off Fall Time	$t_f$		-	3	-	nS
Total Gate Charge	$Q_g$	$V_{DS}=20V, I_D=20A,$ $V_{GS}=10V$	-	17.6	-	nC
Gate-Source Charge	$Q_{gs}$		-	3.5	-	nC
Gate-Drain Charge	$Q_{gd}$		-	3.1	-	nC
Drain-source diode characteristics						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=20A$	-	-	1.2	V
Diode Forward Current	$I_S$		-	-	45	A
Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ\text{C}, I_F = I_S$ $di/dt = 100A/\mu s$	-	11	-	nS
Reverse Recovery Charge	$Q_{rr}$		-	19	-	nC

■ TYPICAL CHARACTERISTICS

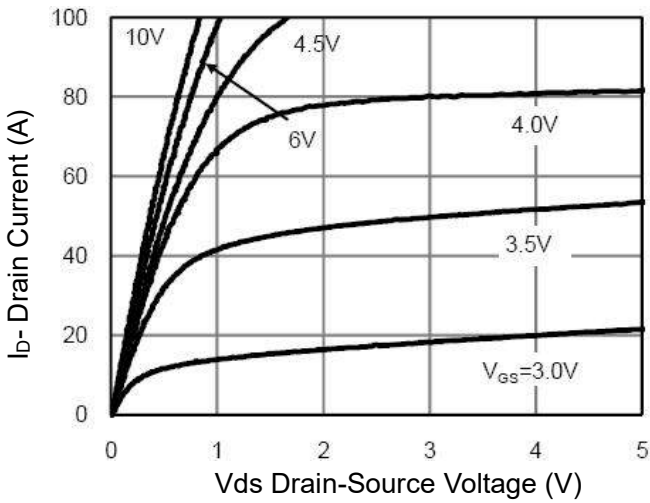


Figure 1 Output Characteristics

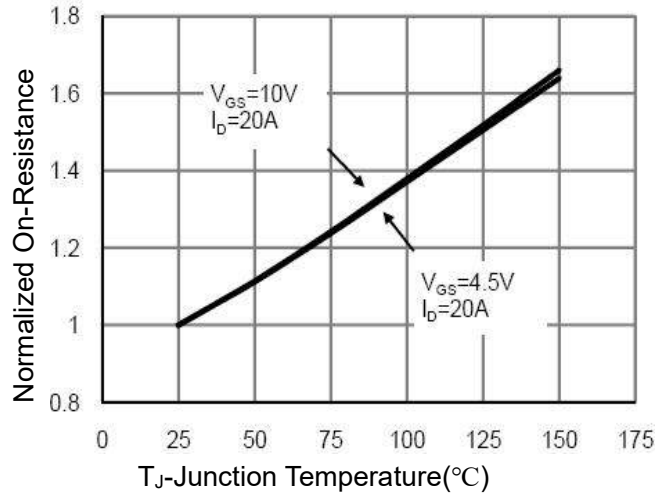


Figure 2  $R_{dson}$ -Junction Temperature

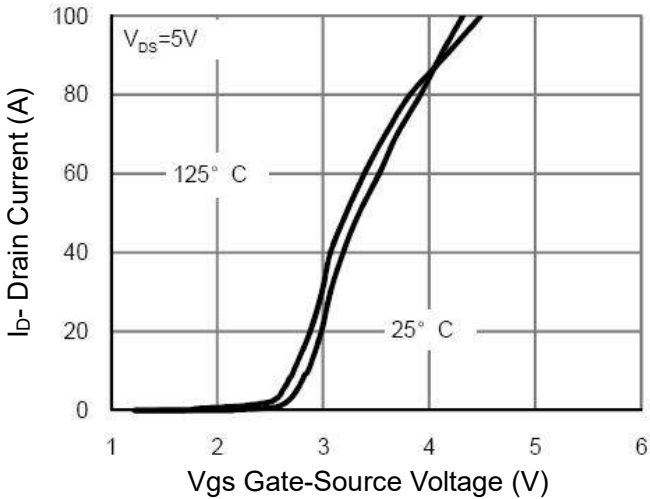


Figure 3 Transfer Characteristics

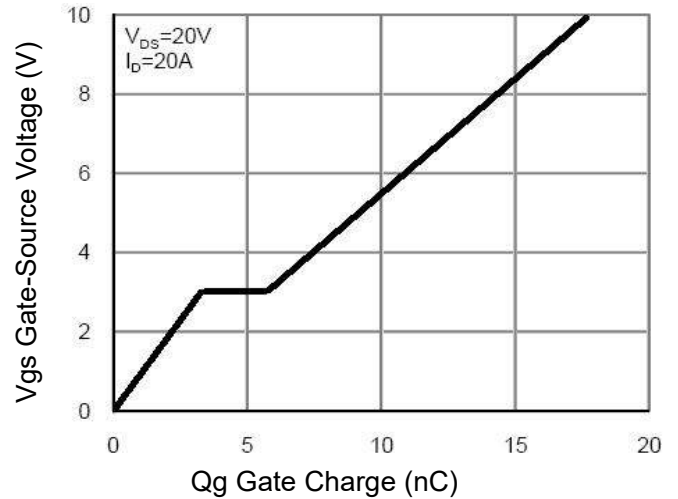


Figure 4 Gate Charge

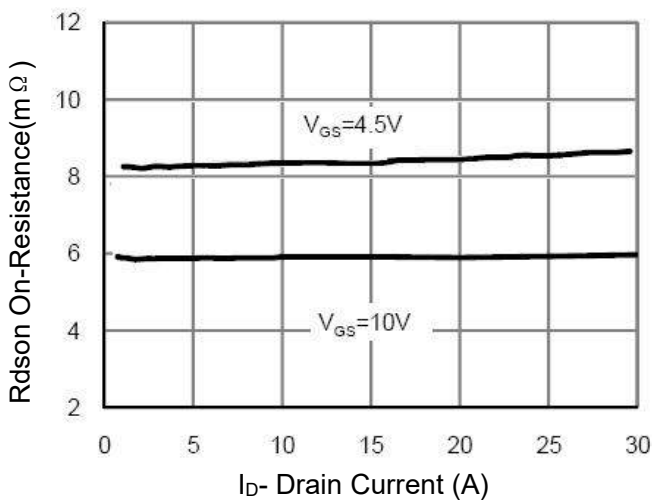


Figure 5  $R_{dson}$ - Drain Current

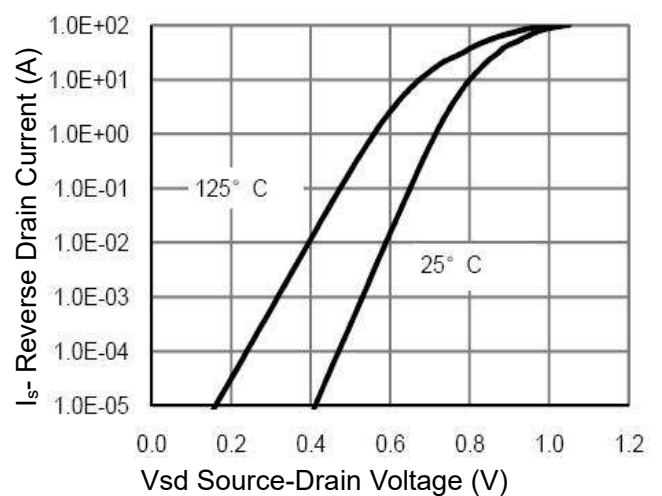


Figure 6 Source- Drain Diode Forward

■ TYPICAL CHARACTERISTICS(Cont.)

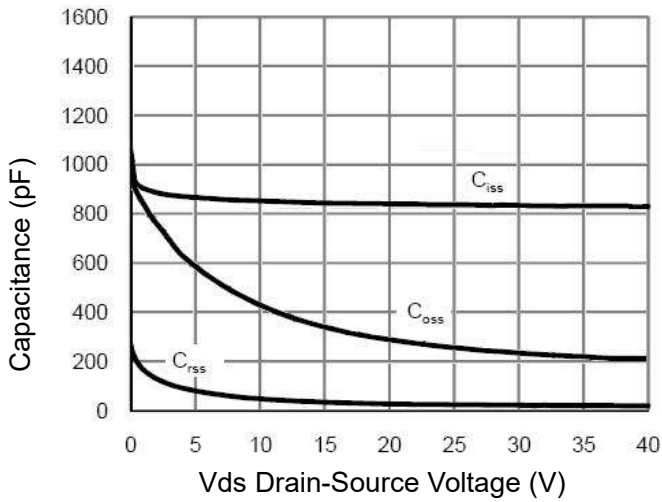


Figure 7 Capacitance vs Vds

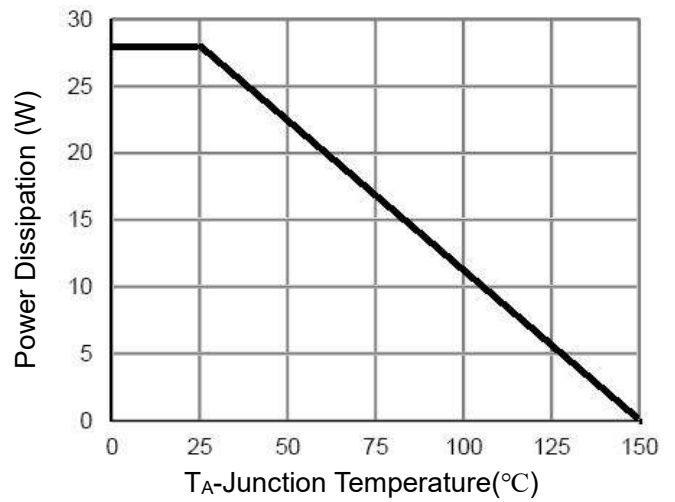


Figure 8 Power De-rating

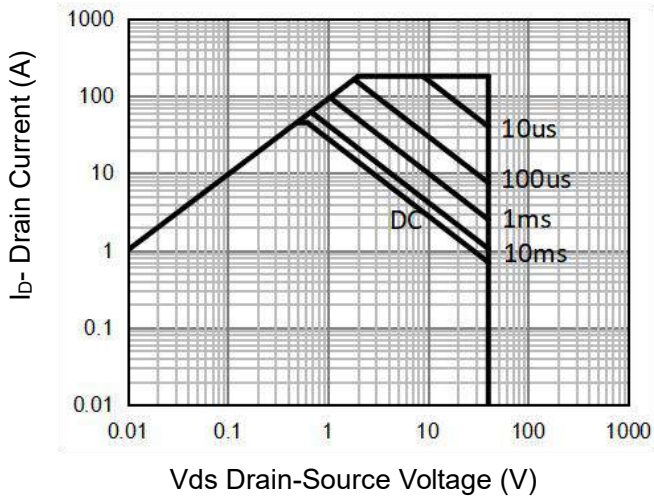


Figure 9 Safe Operation Area (Note 3)

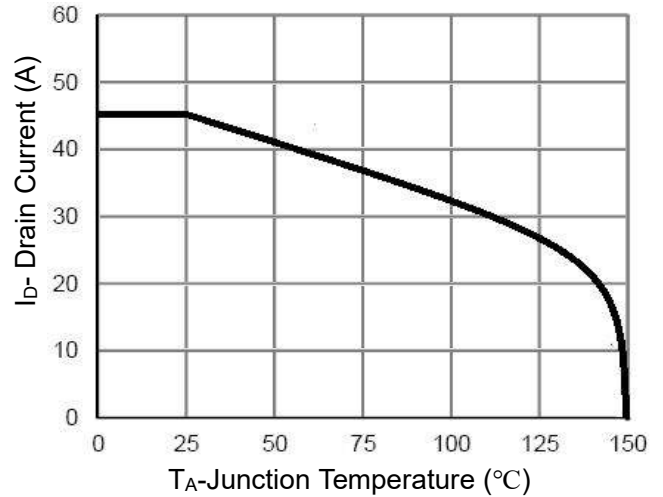


Figure 10 Current De-rating

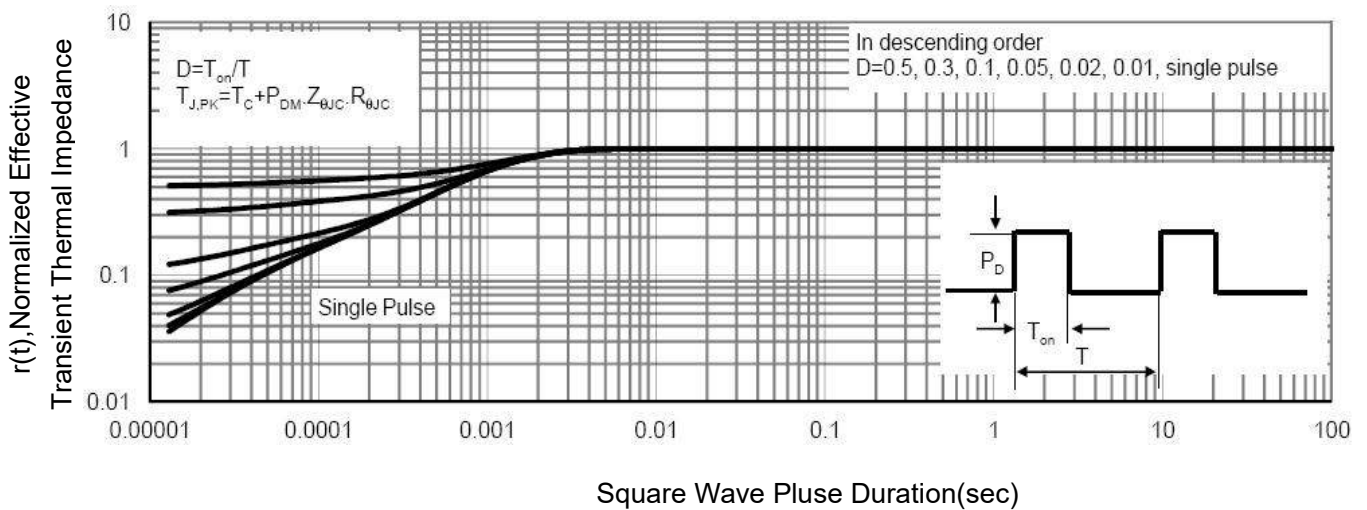
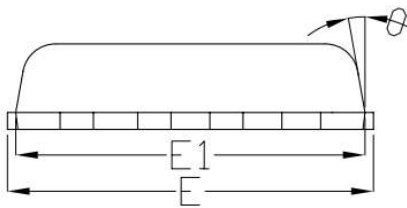
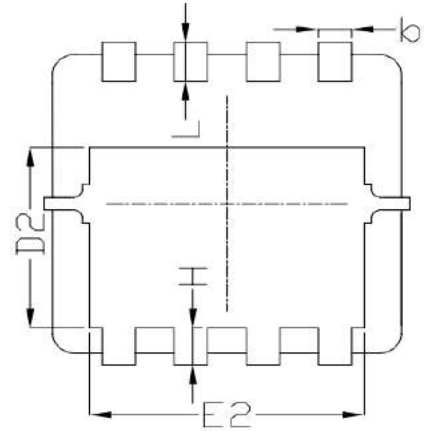
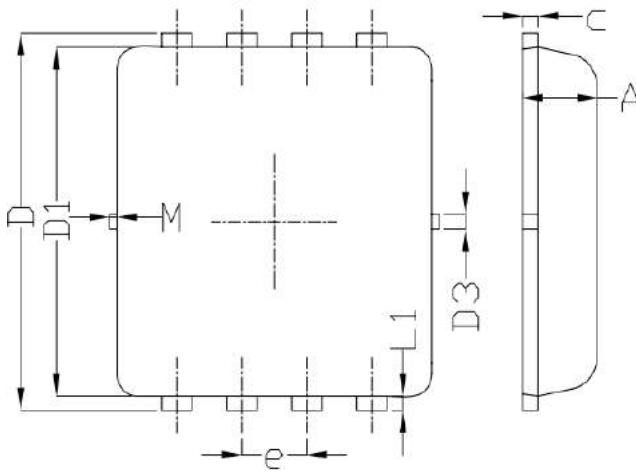
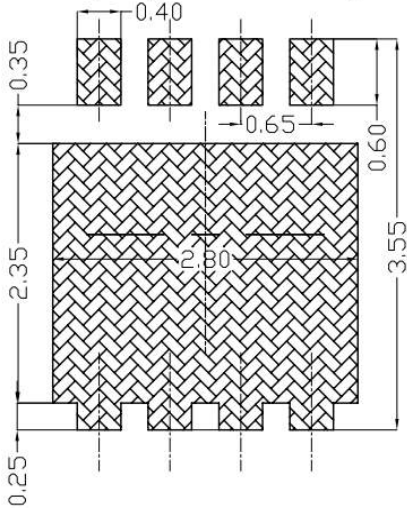


Figure 11 Normalized Maximum Transient Thermal Impedance

■ PDFN3X3-8L Package Mechanical Data



Land Pattern  
(Only for Reference)



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
b	0.25	0.30	0.35
c	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.78	1.88	1.98
D3	---	0.13	---
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e	0.65BSC		
H	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	---	0.13	---
θ	---	10°	12°
M	*	*	0.15
* Not specified			